



AP9221

### SINGLE CHIP BATTERY PROTECTION SOLUTION FOR 1-CELL Li+ BATTERY PACK

## **Description**

The AP9221 is a single chip protection solution specially designed for 1-cell Li+ rechargeable battery pack application.

The AP9221 includes a 1-cell Lithium ion battery protection chip and dual N-CH MOSFET with common drain.

The AP9221 provides rich battery protection features and can turn-off the N-CH MOSFET by detecting overcharge voltage/current, over discharge voltage/current, or load short circuit. The AP9221 has builtin fixed delay time to save external components.

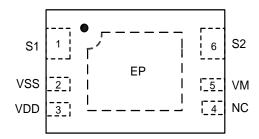
The AP9221 is available in the U-DFN2030-6 (Type C) package.

#### **Features**

- High Voltage CMOS Process, up to 24V (VDD to VM)
- Low Quiescent Current (+25°C)
  - In Normal Mode, 3.0µA (Typ.), 4.5µA (Max.) V<sub>DD</sub> = 3.5V
  - In Power-Down Mode, 0.1µA (Max.)
- High-Accuracy Voltage Detection Circuit (+25°C)
  - Overcharge Detection Voltage: 3.5V to 4.5V (5mV Steps)
    Accuracy-15mV, +25mV
  - Overcharge Hysteresis Voltage Range: 0.1V to 0.4V (50mV Steps) Accuracy ±50mV
  - Overdischarge Detection Voltage: 2.0V to 3.4V (10mV Steps) Accuracy ±35mV
  - Overdischarge Hysteresis Voltage Range: 0V to 0.7V (40mV Steps) Accuracy ±65mV
  - Discharge Overcurrent Detection Voltage: 0.025V to 0.2V (10mV Steps) Accuracy ±12mV
  - Short Current Detection Voltage: 0.12V to 0.45V (50mV Steps) Accuracy ±50mV
  - Charge Overcurrent Detection Voltage: -0.2V to -0.025V (10mV Steps) Accuracy ±12mV
  - Overcharger Detection Voltage: 8.0V (Fixed) Accuracy ±2V
  - Overcharger Release Voltage: 7.3V (Fixed) Accuracy ±2V
- Built-In Fixed Detection Delay Time (+25°C), Accuracy ±20%
- Power-Down Mode Selectable (Yes or No)
- 0V Battery Charge Selectable (Permission or Inhibition)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Pin Assignments**

#### (Top View)



U-DFN2030-6 (Type C)

## **Applications**

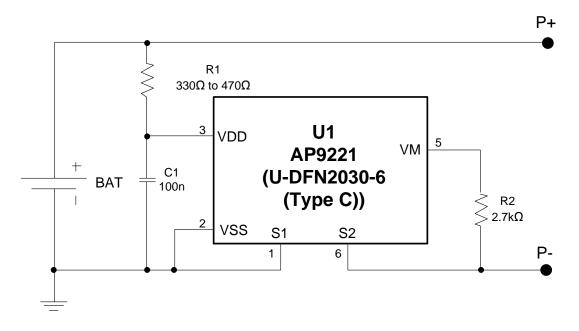
Li+ Rechargeable Battery Pack

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



## **Typical Applications Circuit (Note 4)**



Note:

4. R1 and C1 are used to stabilize the supply voltage of the AP9221. The recommended range of R1 value is  $330\Omega$  to  $470\Omega$  and C1 value is 10nF to 1000nF, typical value is 100nF. R2 should be connected between P- to VM sense terminal to monitor the status of charger and the charge/discharge current. The R2 should be between  $300\Omega$  and  $4k\Omega$ , typical value is  $2.7k\Omega$ . R1 and R2 are also used as current limit resistors if the battery or charger is connected reversely. Polarity reversing may cause the power consumption of R1 and R2 to go over their power dissipation rating, therefore R1 and R2 values should be selected appropriately for the actual application. If R2 is more than  $4k\Omega$  resistor, charge may not be off due to the voltage drop on R2.

For power down mode, when first connecting AP9221 system board to the battery, it is necessary to use charger or to short P- to the battery negative polarity. Once the AP9221 is activated, the charger or connection can be removed, otherwise the battery cannot discharge current through system board.

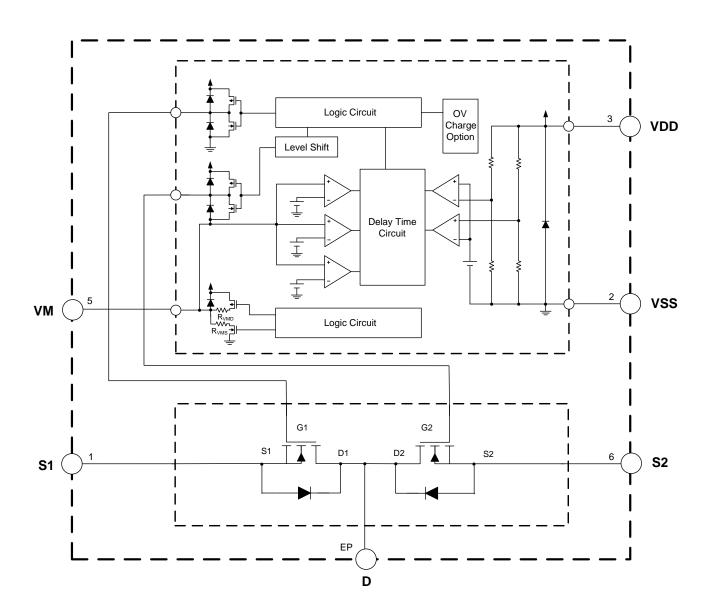
The values selected should follow the recommended typical range mentioned above. It has not been confirmed whether the operation is normal or not in circuits other than the above example of connection. In addition, the example of connection shown above and the typical value do not exactly guarantee proper operation. Please perform the actual application to set the suitable value through your complete evaluation.

## **Pin Descriptions**

Pin Number	Pin Name	Function
1	S1	Source pin of discharging MOSFET, connecting this pin to battery negative pole.
2	VSS	Negative power supply pin
3	VDD	Positive power supply pin, connecting this pin to battery positive pole through R1
4	NC	Not connected, leave this pin floating
5	VM	Charger negative input pin, short this pin to S2 pin through R2
6	S2	Source pin of charging MOSFET, connecting this pin to charge negative input.
EP	D	Thermal PAD is common drain of charge and discharge MOSFET, so in PCB layout, prefer to use large copper area to cover this pad for better thermal dissipation, then leave it open.



# Functional Block Diagram





## Absolute Maximum Ratings (Notes 5 & 6)

Symbol	Parameter	Rating	Unit
$V_{DD}$	Supply Voltage (Between VDD and VSS)	-0.3 to 12	V
$V_{DM}$	Charge Input Voltage (Between VDD and VM for Protection Chip)	-0.3 to 24	V
$V_{DSS}$	MOSFET Drain-to-Source Voltage	20	V
V <sub>GSS</sub>	MOSFET Gate-to-Source Voltage	±12	V
	Continuous Drain Current, V <sub>GS</sub> = 4.5V, T <sub>A</sub> = +25°C	2.8	А
I <sub>D</sub>	Continuous Drain Current, V <sub>GS</sub> = 4.5V, T <sub>A</sub> = +70°C	2.2	А
P <sub>D</sub>	Power Dissipation	1,000	mW
TJ	Maximum Junction Temperature	+150	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
_	ESD (Charged-Device Model)	1,000	V
_	ESD (Human Body Model)	2,000	V

Notes: 5. Stresses beyond those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.

# **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
$V_{DD}$	Supply Voltage (Between VDD and VSS)	1.5	5.5	V
V <sub>DM</sub>	Charge Input Voltage (Between VDD and VM)	-0.3	5.5	V
T <sub>A</sub>	T <sub>A</sub> Operating Ambient Temperature		+85	°C

<sup>6.</sup> Ratings apply to ambient temperature at +25°C. The JEDEC High-K board design used to derive this data was a 2 inch × 2 inch multilayer board with 2-ounce internal power and ground planes and 2-ounce copper traces on the top and bottom of the board.



# Electrical Characteristics (T<sub>A</sub> = +25°C, V<sub>DD</sub> = 3.5V, V<sub>SS</sub> = 0V, R1 = 220Ω, R2 = 1.0kΩ, C1 = 100nF, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
V <sub>CU</sub>	Overcharge Detection Voltage	$V_M = 0V$	V <sub>CU</sub> - 0.015	V <sub>CU</sub>	V <sub>CU</sub> + 0.025	V
		$V_{CL} \neq V_{CU}$	V <sub>CL</sub> - 0.050	V <sub>CL</sub>	V <sub>CL</sub> + 0.050	V
V <sub>CL</sub>	Overcharge Release Voltage	V <sub>CL</sub> = V <sub>CU</sub>	V <sub>CL</sub> - 0.015	V <sub>CL</sub>	V <sub>CL</sub> + 0.025	V
V <sub>DL</sub>	Overdischarge Detection Voltage	$V_M = 0V$	V <sub>DL</sub> - 0.035	V <sub>DL</sub>	V <sub>DL</sub> + 0.035	V
		$V_{DU} \neq V_{DL}$	V <sub>DU</sub> - 0.065	V <sub>DU</sub>	V <sub>DU</sub> + 0.065	V
$V_{DU}$	Overdischarge Release Voltage	$V_{DU} = V_{DL}$	V <sub>DU</sub> - 0.035	$V_{DU}$	V <sub>DU</sub> + 0.035	V
V <sub>DOC</sub>	Discharge Overcurrent Detection Voltage	V <sub>DD</sub> = 3.5V	V <sub>DOC</sub> -0.012	V <sub>DOC</sub>	V <sub>DOC</sub> +0.012	V
V <sub>SHORT</sub>	Load Short-Circuiting Detection Voltage	V <sub>DD</sub> = 3.5V	V <sub>SHORT</sub> -0.050	Vshort	V <sub>SHORT</sub> +0.050	V
Vcoc	Charge Overcurrent Detection Voltage	V <sub>DD</sub> = 3.5V	V <sub>COC</sub> -0.012	Vcoc	V <sub>COC</sub> +0.012	V
I <sub>CC</sub> (Power D	lown Function)	L	0.0.2		, 0.0.2	
Icc	Current Consumption During Operation	$V_{DD} = 3.5V, V_{M} = 0V$	_	3.0	4.5	μA
I <sub>PDN</sub>	Current Consumption During Power Down Mode	V <sub>DD</sub> = 1.8V, VM Pin Floating	_	_	0.1	μΑ
I <sub>CC</sub> (Auto-Wa	ake Up Function)					
I <sub>CC</sub>	Current Consumption During Operation	$V_{DD} = 3.5V, V_{M} = 0V$	_	3	4.5	μΑ
I <sub>AUTO</sub>	Current Consumption During Auto-Wake Mode	V <sub>DD</sub> = 1.8V, VM Pin Floating	_	3.5	5.5	μA
R <sub>VMD</sub>	Resistance Between VM Pin and VDD Pin	$V_{DD} = 1.8V, V_{M} = 0V$	150	300	500	kΩ
R <sub>VMS</sub>	Resistance Between VM Pin and VSS Pin	$V_{DD} = 3.5V, V_{M} = 1.0V$	10	30	50	kΩ
V <sub>0CHA</sub>	0V Battery Charge Starting Charge Voltage	0V battery charging "available"	1.2	_	_	V
V <sub>OINH</sub>	0V Battery Charge Inhibition Battery Voltage	0V battery charging "unavailable"	_	_	0.45	V
V <sub>OVCHG</sub>	Overvoltage Charge Detection Voltage	V <sub>DD</sub> = 3.5V	6.0	8.0	10.0	V
Vovchgr	Overvoltage Charge Release Voltage	V <sub>DD</sub> = 3.5V	5.3	7.3	9.3	V
t <sub>CU</sub>	Overcharge Detection Delay Time	V <sub>DD</sub> = 3.6 to 4.5V	800	1000	1200	ms
t <sub>CUR</sub>	Overcharge Release Delay Time	$V_M = 0V$	1.6	2	2.4	ms
t <sub>DL</sub>	Overdischarge Detection Delay Time	$V_{DD} = 3.6V \text{ to } 2.0V$	92	115	138	ms
t <sub>DLR</sub>	Overdischarge Release Delay Time	$V_M = 0V$	1.6	2	2.4	ms
t <sub>DOC</sub>	Discharge Overcurrent Detection Delay Time	V <sub>DD</sub> = 3.6V	8	10	12	ms
t <sub>DOCR</sub>	Discharge Overcurrent Release Delay Time	$V_M = 0V$	1.6	2	2.4	ms
t <sub>SHORT</sub>	Load Short Detection Delay Time	$V_{DD} = 3.6V$	288	360	432	μs
t <sub>COC</sub>	Charge Overcurrent Detection Delay Time	V <sub>DD</sub> = 3.6V	8	10	12	ms
tcocr	Charge Overcurrent Release Delay Time	$V_M = 0V$	1.6	2	2.4	ms



**Electrical Characteristics** (continued) ( $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{DD} = 3.5V$ ,  $V_{SS} = 0V$ ,  $R1 = 220\Omega$ ,  $R2 = 1.0k\Omega$ , C1 = 100nF, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
Vcu	Overcharge Detection Voltage	$V_M = 0V$	V <sub>CU</sub> - 0.050	Vcu	V <sub>CU</sub> + 0.040	V
.,	Occasionary Balance Vallage	$V_{CL} \neq V_{CU}$	V <sub>CL</sub> - 0.070	V <sub>CL</sub>	V <sub>CL</sub> + 0.060	V
V <sub>CL</sub>	Overcharge Release Voltage	V <sub>CL</sub> = V <sub>CU</sub>	V <sub>CL</sub> - 0.050	V <sub>CL</sub>	V <sub>CL</sub> + 0.040	V
$V_{DL}$	Overdischarge Detection Voltage	$V_M = 0V$	V <sub>DL</sub> - 0.080	$V_{DL}$	V <sub>DL</sub> + 0.080	V
		$V_{DU} \neq V_{DL}$	V <sub>DU</sub> - 0.150	$V_{DU}$	V <sub>DU</sub> + 0.190	V
V <sub>DU</sub>	Overdischarge Release Voltage	$V_{DU} = V_{DL}$	V <sub>DU</sub> - 0.080	$V_{DU}$	V <sub>DU</sub> + 0.080	V
V <sub>DOC</sub>	Discharge Overcurrent Detection Voltage	V <sub>DD</sub> = 3.5V	V <sub>DOC</sub> -0.030	V <sub>DOC</sub>	V <sub>DOC</sub> +0.030	V
V <sub>SHORT</sub>	Load Short-Circuiting Detection Voltage	V <sub>DD</sub> = 3.5V	V <sub>SHORT</sub>	V <sub>SHORT</sub>	V <sub>SHORT</sub> +0.10	V
Vcoc	Charge Overcurrent Detection Voltage	V <sub>DD</sub> = 3.5V	V <sub>COC</sub> -0.040	V <sub>COC</sub>	V <sub>COC</sub> +0.040	V
I <sub>CC</sub> (Power D	own Function)					I
Icc	Current Consumption During Operation	$V_{DD} = 3.5V, V_{M} = 0V$	_	3.0	7.0	μA
I <sub>PDN</sub>	Current Consumption During Power Down Mode	V <sub>DD</sub> = 1.8V, VM Pin Floating	_	_	1.0	μΑ
I <sub>CC</sub> (Auto-Wa	ke Up Function)		•	1	•	
Icc	Current Consumption During Operation	$V_{DD} = 3.5V, V_{M} = 0V$	_	3	4.5	μA
Гаито	Current Consumption During Auto-Wake Mode	V <sub>DD</sub> = 1.8V, VM Pin Floating	_	6	8	μΑ
R <sub>VMD</sub>	Resistance between VM Pin and VDD Pin	V <sub>DD</sub> = 1.8V, V <sub>M</sub> = 0V	100	300	650	kΩ
R <sub>VMS</sub>	Resistance between VM Pin and VSS Pin	V <sub>DD</sub> = 3.5V, V <sub>M</sub> = 1.0V	5	30	65	kΩ
V <sub>0CHA</sub>	0V Battery Charge Starting Charge Voltage	0V battery charging "available"	1.2	_	_	V
V <sub>0INH</sub>	0V Battery Charge Inhibition Battery Voltage	0V battery charging "unavailable"	_	_	0.3	V
Vovchg	Overvoltage Charge Detection Voltage	$V_{DD} = 3.5V$	5.5	8.0	10.5	V
Vovchgr	Overvoltage Charge Release Voltage	$V_{DD} = 3.5V$	5.0	7.3	9.5	V
t <sub>CU</sub>	Overcharge Detection Delay Time	V <sub>DD</sub> = 3.6V to 4.5V	600	1000	1400	ms
t <sub>CUR</sub>	Overcharge Release Delay Time	$V_M = 0V$	1.2	2	2.8	ms
t <sub>DL</sub>	Overdischarge Detection Delay Time	V <sub>DD</sub> = 3.6V to 2.0V	69	115	161	ms
t <sub>DLR</sub>	Overdischarge Release Delay Time	$V_M = 0V$	1.2	2	2.8	ms
tDOC	Discharge Overcurrent Detection Delay Time	V <sub>DD</sub> = 3.6V	6	10	14	ms
t <sub>DOCR</sub>	Discharge Overcurrent Release Delay Time	$V_M = 0V$	1.2	2	2.8	ms
tshort	Load Short Detection Delay Time	V <sub>DD</sub> = 3.6V	216	360	504	μs
tcoc	Charge Overcurrent Detection Delay Time	V <sub>DD</sub> = 3.6V	6	10	14	ms
tcocr	Charge Overcurrent Release Delay Time	$V_M = 0V$	1.2	2	2.8	ms



 $\textbf{Electrical Characteristics} \text{ (continued) (Notes 7 \& 8) } (T_{A} = +25^{\circ}\text{C}, \ V_{DD} = 3.5\text{V}, \ V_{SS} = 0\text{V}, \ R1 = 220\Omega, \ R2 = 1.0k\Omega, \ C1 = 100n\text{F}, \ C1 = 10$ unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0	_	_	1.0	μA
R <sub>SS(ON)1</sub>	Static Source-Source On-Resistance 1	V <sub>DD</sub> = 4.5V, I <sub>D</sub> = 1A	_	130	_	mΩ
R <sub>SS(ON)2</sub>	Static Source-Source On-Resistance 2	$V_{DD} = 3.0V, I_D = 1A$	_	120	_	mΩ
R <sub>SS(ON)2</sub>	Static Source-Source On-Resistance 2	$V_{DD} = 2.5V, I_D = 500mA$	_	120	_	mΩ
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> = 0V I <sub>S</sub> = 1A		0.75	1.0	V

7. In case of Gate-Source voltage of charging MOSFET is 0V. In case of Gate-Source voltage of discharging MOSFET is 0V. 8. These specifications are guaranteed by design - will not be tested in production. Notes:

August 2019

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## **Application Information**

#### **Operation Mode**

#### 1. Normal Status

The AP9221 monitors the battery voltage between the VDD pin and VSS pin as well as the voltage difference between the VM pin and VSS pin to control battery charging and discharging. When the battery voltage is between overdischarge detection voltage ( $V_{CU}$ ) as well as the VM pin voltage is between the charge overcurrent detection voltage ( $V_{COC}$ ) and discharge overcurrent detection voltage ( $V_{DCC}$ ), the AP9221 will turn on discharging and charging MOSFET. In these conditions, the battery can charge and discharge freely. Also,  $R_{VMD}$  does not connect to VDD pin and  $R_{VMS}$  does not connect to VSS pin in this status.

#### 2. Overcharge Status

If the battery voltage is more than  $V_{CU}$  during charging status for the overcharge detection delay time ( $t_{CU}$ ) or longer, the AP9221 turns off the charging MOSFET to stop charging.  $R_{VMD}$  and  $R_{VMS}$  are not connected in overcharge status.

When VM pin voltage is lower than  $V_{DOC}$  and battery voltage falls below  $V_{CL}$ , the AP9221 will release from overcharge status. When VM pin voltage is equal or more than  $V_{DOC}$  and battery voltage falls below  $V_{CU}$ , the AP9221 will release from overcharge status.

#### 3. Overdischarge Status

If the battery voltage is less than  $V_{DL}$  during discharging status for the overdischarge detection delay time ( $t_{DL}$ ) or longer, the AP9221 turns off the discharging MOSFET to stop discharging. In overdischarge status,  $R_{VMD}$  is connected to VDD and VM pin voltage is pulled up to  $V_{DD}$  by  $R_{VMD}$ , but  $R_{VMS}$  is not connected. For power-down mode version, the AP9221 recovers normal status from overdischarge status only by charging the battery through the charger.

When VM pin voltage to VSS pin voltage is less than typical -0.7V and the battery voltage rises over  $V_{DL}$ , the AP9221 will release from overdischarge status. If VM pin voltage to VSS pin voltage is higher than typical -0.7V, the AP9221 will release from overdischarge status until the battery voltage rises over  $V_{DL}$ .

For auto-wake-up version AP9221SA, the device recovers to normal status from overdischarge status if either of these two conditions are satisfied:

If charger is connected: the AP9221SA overdischarge status is released in the same way as described above in AP9221S Overdischarge Status

section.

If no charger is connected: 1) The battery voltage reaches the overdischarge release voltage (V<sub>DU</sub>) or higher;

2) Maintains continuous time more than overdischarge release delay time t<sub>DLR</sub>.

#### 4. Discharge Overcurrent and Short Current Status

When battery is in discharge overcurrent status, if the voltage of the VM pin to VSS pin is equal or more than  $V_{DOC}$  to  $V_{SHORT}$  and detection lasts for the discharge overcurrent detection delay time ( $t_{DOC}$ ) or longer, the AP9221 turns off the discharging MOSFET to stop discharging.

When the battery is in short current status, if the voltage of the VM pin to VSS pin is equal to or more than V<sub>SHORT</sub>, and the detection lasts for the short current detection delay time or longer, the AP9221 turns off the discharge MOSFET to stop discharging.

In discharge overcurrent or short current status,  $R_{VMS}$  is connected to  $V_{SS}$  but  $R_{VMD}$  is not connected. The voltage of VM pin is almost equal to  $V_{DD}$  as long as the load is connected. When the load is disconnected, the voltage of VM pin will become almost equal to  $V_{SS}$  (due to  $R_{VMS}$  being connected) and then the AP9221 will release from discharge overcurrent or short current status.

#### 5. Charge Overcurrent Status

When the battery is in charge current status, if the voltage of the VM pin to VSS pin is equal to or less than  $V_{COC}$  and the detection continues for the charge overcurrent detection delay time ( $t_{COC}$ ) or longer, the AP9221 turns off the charging MOSFET to stop charging.

#### 6. 0V Battery Charging Function (Option)

This function is available as an option and can be factory set internally. AP9221 has this function built in.

0V charging function permits charger to recharge the battery whose voltage is 0V due to self-discharge. If 0V charging function is not present, the device will prevent charger to recharge the battery whose voltage is 0V due to self-discharge. (If a device without 0V charging function is needed, please contact Diodes Incorporated sales team.)



## **Application Information** (continued)

### 7. Overvoltage Charger Detection Circuit

This function is used to monitor the charger voltage between the VDD pin and VM pin, and when this voltage exceeds overvoltage charger detection voltage (8.0V Typ.), the AP9221 will turn off charging MOSFET, when this voltage drops below overvoltage charger release voltage (7.3V Typ.), it then turns on charging MOSFET. There are no delay times set for detection and release.

#### 8. Power-Down Mode or Auto-Wake-Up Function Option

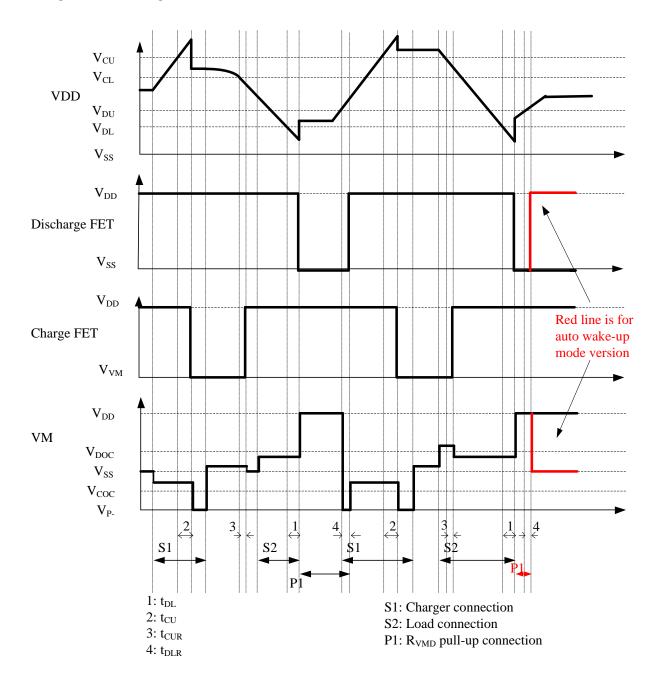
In device with power-down function, during power-down mode, device enters the overdischarge status. The IC enters sleep mode and the current consumption becomes very low, typically 0.1µA. To release from power-down status to the normal status, charger connection is required.

In device with auto-wakeup mode, the IC remains active in the overdischarge state. The IC is released into the normal state by the operation that increases the battery voltage more than overdischarge release voltage.



# **Application Information (Timing Chart)**

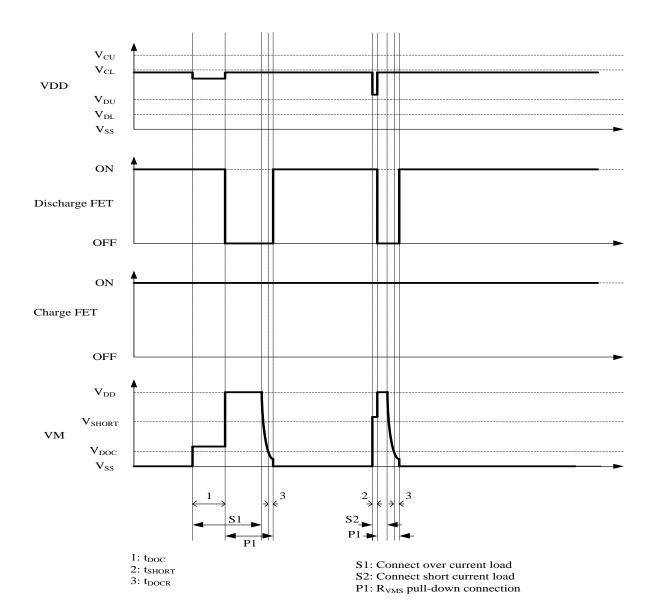
## 1. Overcharge and Overdischarge Detection





# Application Information (Timing Chart) (continued)

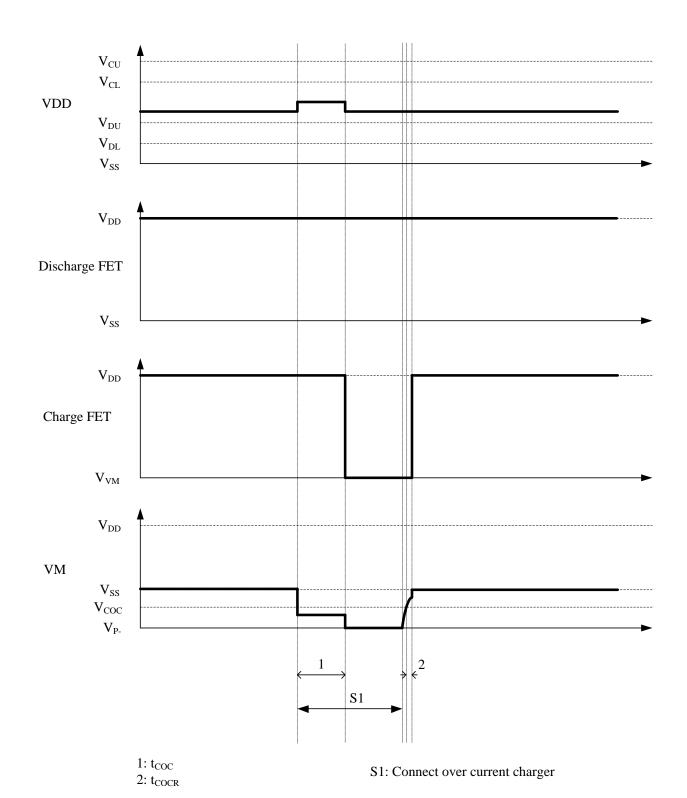
## 2. Discharge Overcurrent Detection





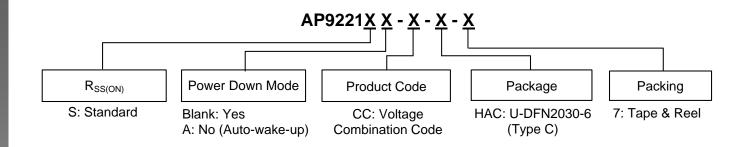
# Application Information (Timing Chart) (continued)

## 3. Charge Overcurrent Detection





## **Ordering Information**



Part Number	Part Number Package Code		7" Tape and Reel Quantity	
AP9221SA-CC-HAC-7	HAC	U-DFN2030-6 (Type C)	3000/Tape & Reel	

## **Voltage Combination (Note 9)**

Part Number	Overcharge Detection Voltage V <sub>CU</sub> (V)	Overcharge Release Voltage V <sub>CL</sub> (V)	Over- discharge Detection Voltage V <sub>DL</sub> (V)	Over- discharge Release Voltage	Discharge Overcurrent Detection Voltage V <sub>DOC</sub> (V)	Load Short Detection Voltage V <sub>SHORT</sub> (V)	Charge Overcurrent Detection Voltage V <sub>COC</sub> (V)	Overvoltage Charge Detection Voltage V <sub>OVCHG</sub> (V)	Overvoltage Charge Release Voltage V <sub>OVCHGR</sub> (V)	Power- down Function	Overcharge Protection Mode	0V Battery Charge Function
AP9221SA-CC-HAC-7	4.2	4.0	2.75	2.95	0.055	0.276	-0.113	8.0	7.3	Auto Wake- up	Auto Release	Prohibition

Note: 9. If any other voltage version options are needed, please contact the local sales office.

### **AP9221 Delay Time Combination**

Part Number	Overcharge Detection Delay Time tcu	Overcharge Release Delay Time tcur	Overdischarge Detection Delay Time t <sub>DL</sub>	Overdischarge Release Delay Time t <sub>DLR</sub>	Discharge Overcurrent Detection Delay Time tDOC	Discharge Overcurrent Release Delay Time	Charge Overcurrent Detection Delay Time tCOC	Charge Overcurrent Release Delay Time	Load Short Detection Delay Time tshort
AP9221SA-CC-HAC-7	1.0s	2.0ms	115ms	2.0ms	10.0ms	2.0ms	10.0ms	2.0ms	360µs



# Marking Information

U-DFN2030-6 (Type C)

(Top View)

<u>XX</u> <u>Y W X</u>  $\underline{XX}$ : Identification Code  $\underline{Y}$ : Year: 0~9

<u>W</u>: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents 52 and 53 week

 $\underline{X}$ : A~Z: Internal Code

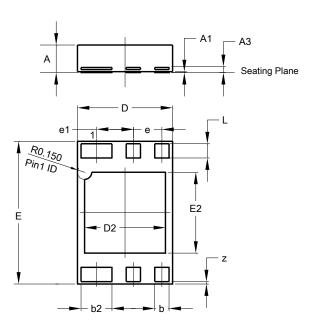
Part Number	Package	Identification Code	
AP9221SA-CC-HAC-7	U-DFN2030-6 (Type C)	2C	



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-DFN2030-6 (Type C)

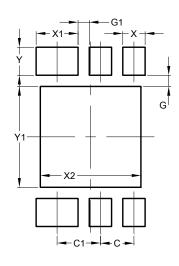


	U-DFN2030-6 (Type C)						
Dim	im Min Max Typ						
Α	0.50	0.60					
A1	0.00	0.05	0.02				
A3			0.127				
b	0.25	0.35	0.30				
b2	0.60	0.70	0.65				
D	1.90	2.10	2.00				
D2	1.60	1.80	1.70				
Е	2.90	3.10	3.00				
E2	1.60	1.80	1.70				
е	-	-	0.60				
e1			0.775				
L	0.25 0.35 0.30						
z	z 0.0500 Ref						
All	All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-DFN2030-6 (Type C)



Dimensions	Value (in mm)
С	0.600
C1	0.775
G	0.200
G1	0.200
X	0.400
X1	0.750
X2	1.800
Y	0.500
Y1	1.800



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